



TO-252-2L Plastic-Encapsulate MOSFETs

CJU03N80 N-Channel Power MOSFET

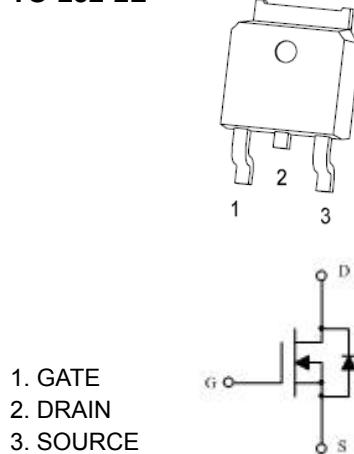
GENERAL DESCRIPTION

The CJU03N80 provide excellent $R_{DS(ON)}$, low gate charge and operation with low gate voltages. This device is suitable for use as a load switch or in PWM applications.

FEATURE

- Excellent package for good heat dissipation
- Ultra low gate charge
- Low reverse transfer capacitance
- Fast switching capability
- Avalanche energy specified

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APPLICATION

- Power switching application

Maximum ratings ($T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	800	V
Gate-Source Voltage	V_{GS}	± 30	
Continuous Drain Current	I_D	3	A
Pulsed Drain Current	I_{DM}	10	
Single Pulsed Avalanche Energy (note1)	E_{AS}	170	mJ
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	100	$^\circ\text{C}/\text{W}$
Junction Temperature	T_J	150	$^\circ\text{C}$
Storage Temperature Range	T_{STG}	-55 ~+150	
Maximum lead temperature for soldering purposes , 1/8"from case for 5 seconds	T_L	260	

Electrical characteristics ($T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Off characteristics						
Drain-source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	$V_{GS} = 0V, I_D = 250\mu\text{A}$	800			V
Zero gate voltage drain current	I_{DSS}	$V_{DS} = 800V, V_{GS} = 0V$			1	μA
Gate-body leakage current	I_{GSS}	$V_{DS} = 0V, V_{GS} = \pm 30V$			± 10	μA
On characteristics						
Gate-threshold voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	3		4.5	V
Static drain-source on-resistance	$R_{DS(\text{on})}$	$V_{GS} = 10V, I_D = 1.5\text{A}$			4.2	Ω
Forward transconductance (note2)	g_{fs}	$V_{DS} = 15V, I_D = 1.5\text{A}$		2.1		S
Dynamic characteristics (note 3)						
Input capacitance	C_{iss}	$V_{DS} = 25V, V_{GS} = 0V, f = 1\text{MHz}$		485		pF
Output capacitance	C_{oss}			57		
Reverse transfer capacitance	C_{rss}			11		
Switching characteristics (note 2,3)						
Turn-on delay time	$t_{d(on)}$	$V_{DD} = 400V, R_G = 4.7\Omega, I_D = 3\text{A}, V_{GS} = 10V$		17		ns
Turn-on rise time	t_r			27		
Turn-off delay time	$t_{d(off)}$			36		
Turn-off fall time	t_f			40		
Total Gate Charge	Q_g	$V_{DS} = 640V, V_{GS} = 10V, I_D = 3\text{A}$		19		nC
Gate-Source Charge	Q_{gs}			3.2		nC
Gate-Drain Charge	Q_{gd}			10.8		nC
Drain-Source Diode Characteristics						
Drain-source diode forward voltage	V_{SD}	$V_{GS} = 0V, I_S = 3\text{A}$			1.6	V
Continuous drain-source diode forward current	I_S				3	A
Pulsed drain-source diode forward current	I_{SM}				10	A

Notes :

1. $L = 35\text{mH}, I_L = 3\text{A}, V_{DD} = 50V, R_G = 25\Omega$, Starting $T_J = 25^\circ\text{C}$.
2. Pulse Test : Pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.
3. Guaranteed by design, not subject to production